



SEA & LAND ELECTRONIC CORP.

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ALPHA-TOP TECHNOLOGY CORP.

WWW.ALPHA-TOP.CN

APPROVAL SHEET

MODEL NO.: SMD1210-075-13.2V

CUSTOMER:

CUSTOMER'S APPROVAL:

AUTHORIZED SIGNATURE/STAMP:

DATE

MANUFACTURER:

HEAD OFFICE:

13F., No. 120-10, Sec. 3, Zhongshan Rd., Zhonghe Dist., New Taipei City 23544, Taiwan
Tel: 886-2-8221-2567
Fax: 882-2-2225-7268
E-mail: service@chipfast.com.tw

China Branch:

Factory Building B) Shuangpeng, Weibu Village, Qiuchang Town,
Huiyang District, Huizhou City, Guangdong Province, P.R.C.)
Tel: 86-752-3562001
Fax: 86-752-3558696
E-mail: service@atpptc.com

Submitted by: Chung Cheng
Approved by: YC Lin
DATE: 15-Sep-21

SEA & LAND ELECTRONIC CORP.



Features

- Surface Mount Devices
- Lead free device
- Size 3.2*2.5mm/0.12*0.10 inch
- Surface Mount packaging for automated assembly

Applications

Almost anywhere there is a low voltage power supply, up to 30V and a load to be protected, including:
■ Computer mother board, Modem.
■ Telecommunication equipments.

SMD1210-075-13.2V

Alpha-Top (Sea&Land Alliance)

Performance Specification

Model	Marking	V_{max}	I_{max}	I_{hold}	I_{trip}	P_d	Maximum Time To Trip		Resistance		Agency Approval	
		(Vdc)	(A)	@25°C (A)	@25°C (A)	Max. (W)	Current (A)	Time (Sec)	R_{imin} (Ω)	$R1max$ (Ω)	UL	TUV
SMD1210-075-13.2V	αG	13.2	100	0.75	1.50	0.6	8.0	0.10	0.070	0.400		

I_{hold} = Hold Current. Maximum current device will not trip in 25°C still air.
I_{trip} = Trip Current. Minimum current at which the device will always trip in 25°C still air.
V_{max} = Maximum operating voltage device can withstand without damage at rated current (I_{max}).
I_{max} = Maximum fault current device can withstand without damage at rated voltage (V_{max}).
P_d = Power dissipation when device is in the tripped state in 25°C still air environment at rated voltage.
R_{imin/max} = Minimum/Maximum device resistance prior to tripping at 25°C.
R_{1max} = Maximum device resistance is measured one hour post reflow.
CAUTION : Operation beyond the specified ratings may result in damage and possible arcing and flame.

Environmental Specifications

Test	Conditions	Resistance change
Passive aging	+85°C, 1000 hrs.	±5% typical
Humidity aging	+85°C, 85% R.H. , 168 hours	±5% typical
Thermal shock	+85°C to -40°C, 20 times	±33% typical
Resistance to solvent	MIL-STD-202, Method 215	No change
Vibration	MIL-STD-202, Method 201	No change
Ambient operating conditions : - 40 °C to +85 °C		
Maximum surface temperature of the device in the tripped state is 125 °C		

Agency Approvals :

Regulation/Standard:



2015/863/EU



EN14582

I_{hold} Versus Temperature

Model	Maximum ambient operating temperature (T _{mao}) vs. hold current (I _{hold})								
	-40°C	-20°C	0°C	25°C	40°C	50°C	60°C	70°C	85°C
SMD1210-075-13.2V	1.00	0.97	0.86	0.75	0.64	0.59	0.54	0.48	0.40

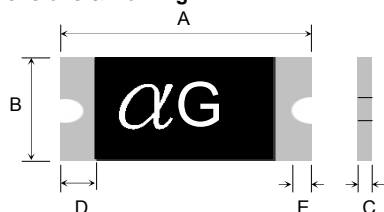
SMD1210-075-13.2V

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Construction And Dimension (Unit:mm)

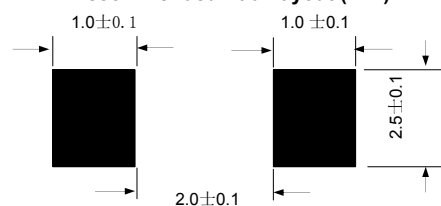
Model	A		B		C		D		E	
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.
SMD1210-075-13.2V	3.00	3.43	2.35	2.80	0.50	1.20	0.30	0.30	0.10	0.10

Dimensions & Marking



α = Trademark
G = Part identification

Recommended Pad Layout (mm)



Termination Pad Characteristics

Terminal pad materials :

Tin-plated Nickel-Copper

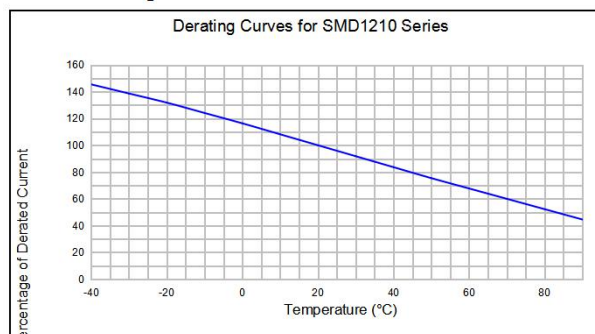
Terminal pad solderability :

Meets EIA specification RS186-9E and ANSI/J-STD-002 Category 3.

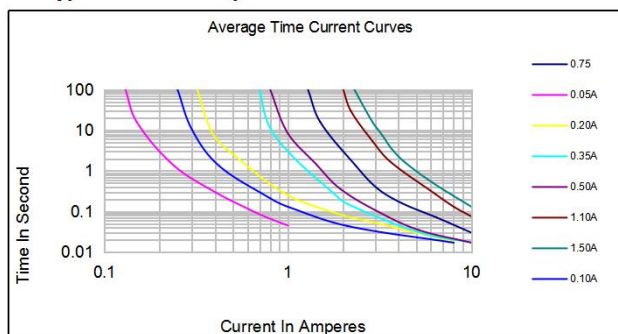
Rework

Use standard industry practices, the removal device must be replaced with a fresh one.

Thermal Derating Curve



Typical Time-To-Trip At 25°C



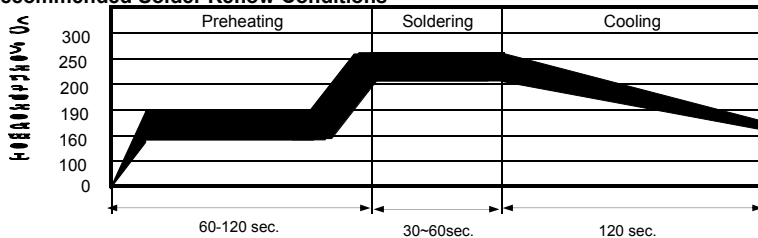
WARNING:

- Use PPTC beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.
- PPTC are intended for protection against occasional over current or over temperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated.
- Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.
- Use PPTC with a large inductance in circuit will generate a circuit voltage (L di/dt) above the rated voltage of the PPTC.
- Avoid impact PPTC device its thermal expansion like placed under pressure or installed in limited space.
- Contamination of the PPTC material with certain silicon based oils or some aggressive solvents can adversely impact the performance of the devices. PPTC SMD can be cleaned by standard methods.
- Requests that customers comply with our recommended solder pad layouts and recommended reflow profile. Improper board layouts or reflow profile could negatively impact solderability performance of our devices.

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Recommended Solder Reflow Conditions

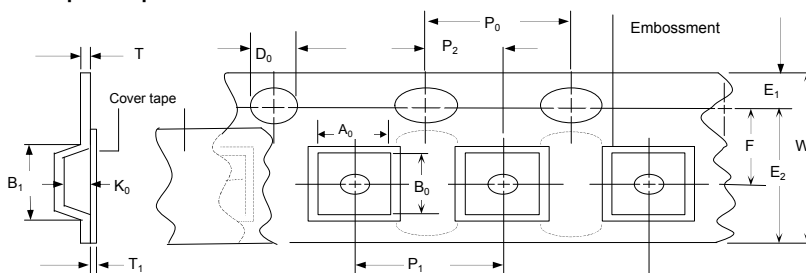


- Recommended reflow methods : IR, vapor phase oven, hot air oven.
 - Devices are not designed to be wave soldered to the bottom side of the board.
 - Recommended maximum paste thickness is 0.25 mm (0.010 inch).
 - Devices can be cleaned using standard method and solvents.
- Note : If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

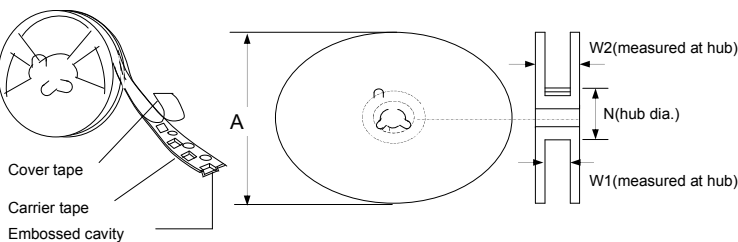
Tape And Reel Specifications (mm)

Governing Specifications	EIA 481-2
W	8.0 ± 0.20
P0	4.0 ± 0.10
P1	4.0 ± 0.10
P2	2.0 ± 0.10
A0	2.82 ± 0.10
B0	3.52 ± 0.10
B1max.	4.35
D0	1.5 + 0.1, -0.0
F	7.5 ± 0.05
E1	1.75 ± 0.10
E2min.	6.25
Tmax.	0.6
T1max.	0.1
K0	0.90 ± 0.1
Leader min.	390
Trailer min.	160
Reel Dimensions	
A max.	178
N min.	50
W1	8.4 + 1.5, -0.0
W2max.	22.4

EIA Tape Component Dimensions



EIA Reel Dimensions



Storage And Handling

- Storage conditions : 40°C max, 70% R.H.
- Devices may not meet specified performance if storage conditions are exceeded.

Order Information

SMD1210	075-13.2V	Packaging
Product name	Hold	Tape & Reel Quantity
Size 3225 mm / 1210 inch	Current	4,000 pcs/reel
SMD : surface mount device	0.75A	

Tape & reel packaging per EIA481-1

Labeling Information

